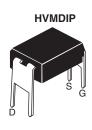
**Vishay Siliconix** 

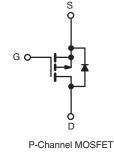
RoHS

COMPLIANT

### **Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	- 60				
R <sub>DS(on)</sub> (Ω)	$V_{GS} = -10 V$	0.50			
Q <sub>g</sub> (Max.) (nC)	12				
Q <sub>gs</sub> (nC)	3.8				
Q <sub>gd</sub> (nC)	5.1				
Configuration	Single				





#### FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- For Automatic Insertion
- End Stackable
- P-Channel
- 175 °C Operating Temperature
- Fast Switching
- Compliant to RoHS Directive 2002/95/EC

#### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain servers as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION			
Package	HVMDIP		
Lead (Pb)-free	IRFD9014PbF		
	SiHFD9014-E3		
SnPb	IRFD9014		
	SiHFD9014		

<b>ABSOLUTE MAXIMUM RATINGS (TA</b>	= 25 °C, unless otherwis	se noted)			
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V <sub>DS</sub>	- 60	- V		
Gate-Source Voltage	V <sub>GS</sub>	± 20			
Continuous Drain Current	$V_{GS}$ at - 10 V $T_A = 25 \degree C$ $T_A = 100 \degree C$	I <sub>D</sub>	- 1.1		
	$V_{GS}$ at - 10 V $T_A = 100 \text{ °C}$		- 0.80	А	
Pulsed Drain Current <sup>a</sup>	I <sub>DM</sub>	- 8.8			
Linear Derating Factor		0.0083	W/°C		
Single Pulse Avalanche Energy <sup>b</sup>	E <sub>AS</sub>	140	mJ		
Avalanche Current <sup>a</sup>	I <sub>AR</sub>	- 1.1	А		
Repetitive Avalanche Energy <sup>a</sup>		E <sub>AR</sub>	0.13	mJ	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	PD	1.3	W	
Peak Diode Recovery dV/dt <sup>c</sup>		dV/dt	- 4.5	V/ns	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	00	
Soldering Recommendations (Peak Temperature)	for 10 s		300 <sup>d</sup>	°C	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b.  $V_{DD}$  = - 25 V, starting T<sub>J</sub> = 25 °C, L = 33 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = - 2.2 A (see fig. 12).

c.  $I_{SD} \leq$  - 6.7 A, dI/dt  $\leq$  90 A/µs,  $V_{DD} \leq V_{DS}$ ,  $T_J \leq$  175 °C.

d. 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	ТҮР		MAX.		UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	- 120			°C/W			
	I							
SPECIFICATIONS (T <sub>J</sub> = 25 °C, u	nless otherw	ise noted)						
PARAMETER	SYMBOL	TES	T CONDITI	ONS	MIN.	TYP.	MAX.	UNIT
Static		•						
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	0 V, I <sub>D</sub> = - 2	250 µA	- 60	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I	<sub>D</sub> = - 1 mA	-	- 0.060	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = - 250 μA			- 2.0	-	- 4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	,	$V_{GS} = \pm 20$	V	-	-	± 100	nA
		V <sub>DS</sub> = - 60 V, V <sub>GS</sub> = 0 V		-	-	-100	μA	
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> = - 48 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C		-	-	- 500		
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 10 V	I <sub>D</sub> =	- 0.66 A <sup>b</sup>	-	-	0.50	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = -	25 V, I <sub>D</sub> = -	0.66 A <sup>b</sup>	0.70	-	-	S
Dynamic		•				•		
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = -25 V,$ f = 1.0 MHz, see fig. 5		-	270	-	pF	
Output Capacitance	Coss			-	170	-		
Reverse Transfer Capacitance	C <sub>rss</sub>			-	31	-		
Total Gate Charge	Qg			I <sub>D</sub> = - 6.7 A, V <sub>DS</sub> = - 48 V, see fig. 6 and 13 <sup>b</sup>	-	-	12	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = - 10 V			-	-	3.8	
Gate-Drain Charge	Q <sub>gd</sub>	. See lig			-	-	5.1	1
Turn-On Delay Time	t <sub>d(on)</sub>				-	11	-	
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 30 V, $I_D$ = - 6.7 A, $R_g$ = 24 $\Omega,R_D$ = 4.0 $\Omega,see$ fig. $10^b$		-	63	-	- ns	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	10	-		
Fall Time	t <sub>f</sub>			-	31	-		
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.0	-	- nH	
Internal Source Inductance	Ls			-	6.0	-		
Drain-Source Body Diode Characteristic	s							
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	- 1.1		
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	- 8.8	A	
Body Diode Voltage	V <sub>SD</sub>	$T_J = 25 \text{ °C}, I_S = -1.1 \text{ A}, V_{GS} = 0 \text{ V}^{b}$		-	-	- 5.5	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	$T_{\rm J} = 25 \ ^{\circ}{\rm C}, I_{\rm F} = -6.7 \ {\rm A}, \ {\rm dl}/{\rm dt} = 100 \ {\rm A}/{\rm \mu}{\rm s}^{\rm b}$		-	80	160	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	0.096	0.19	μC	
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S$ and $L_D$ )						L <sub>D</sub> )

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq$  300  $\mu s;$  duty cycle  $\leq$  2 %.



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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

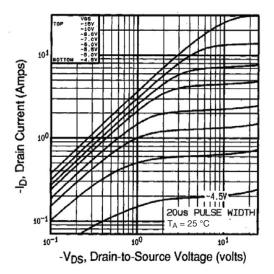


Fig. 1 - Typical Output Characteristics, T<sub>A</sub> = 25 °C

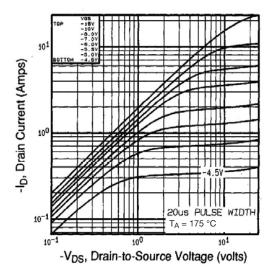


Fig. 2 - Typical Output Characteristics,  $T_A$  = 175 °C

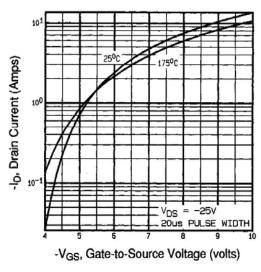


Fig. 3 - Typical Transfer Characteristics

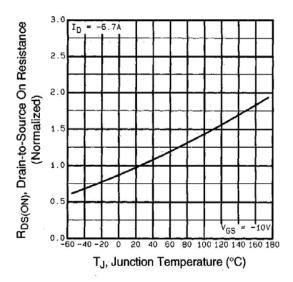


Fig. 4 - Normalized On-Resistance vs. Temperature

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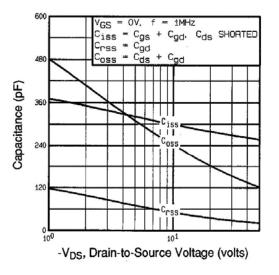


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

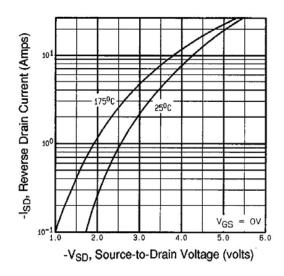


Fig. 7 - Typical Source-Drain Diode Forward Voltage

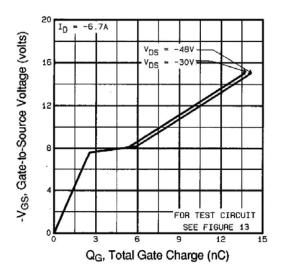


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

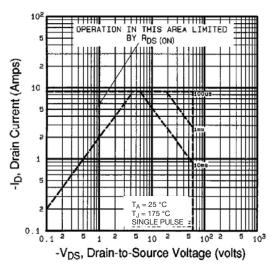


Fig. 8 - Maximum Safe Operating Area



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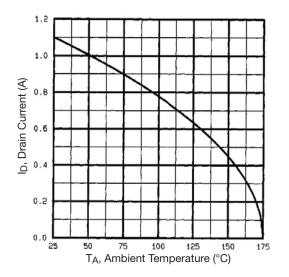


Fig. 9 - Maximum Drain Current vs. Ambient Temperature

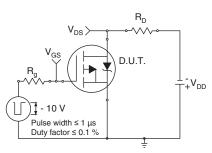


Fig. 10a - Switching Time Test Circuit

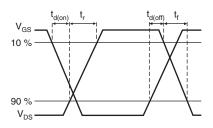


Fig. 10b - Switching Time Waveforms

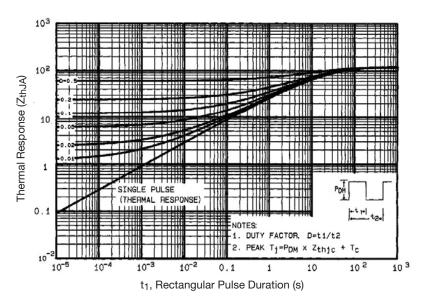


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

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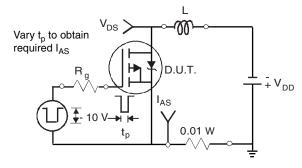


Fig. 12a - Unclamped Inductive Test Circuit

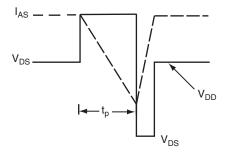


Fig. 12b - Unclamped Inductive Waveforms

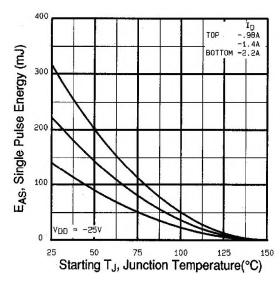


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

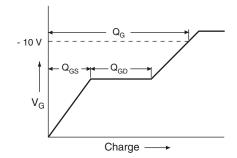


Fig. 13a - Basic Gate Charge Waveform

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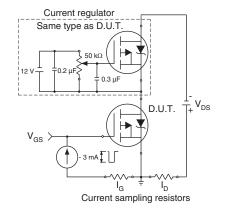
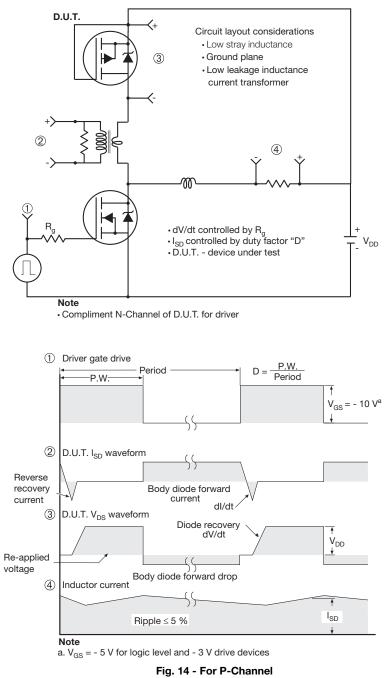


Fig. 13b - Gate Charge Test Circuit



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Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?91136">www.vishay.com/ppg?91136</a>.

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